Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

- Small Size
- · Passivated Die for Reliability and Uniformity
- Low Level Triggering and Holding Characteristics
- Available in Two Package Styles
 Surface Mount Lead Form Case 369A
 Miniature Plastic Package Straight Leads Case 369

ORDERING INFORMATION

- To Obtain "DPAK" in Surface Mount Leadform (Case 369A)
 Shipped in Sleeves No Suffix, i.e. MCR8DSN
 Shipped in 16 mm Tape and Reel Add "T4" Suffix to Device Number, i.e. MCR8DSNT4
- To Obtain "DPAK" in Straight Lead Version (Case 369) Shipped in Sleeves Add "-1" Suffix to Device Number, i.e. MCR8DSN-1

MCR8DSM MCR8DSN

Motorola Preferred Devices

SCRs 8.0 AMPERES RMS 600 thru 800 VOLTS



CASE 369A-13 STYLE 4

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating		Symbol	Value	Unit
Peak Repetitive Off–State Voltage (1) Peak Repetitive Reverse Voltage (T _J = -40 to 110°C, R _{GK} = 1.0 KΩ)	MCR8DSM MCR8DSN	VDRM VRRM	600 800	Volts
On–State RMS Current (All Conduction Angles; T _C = 90°C)		I _{T(RMS)}	8.0	Amps
Average On–State Current (All Conduction Angles; T _C = 90°C)	300	I _{T(AV)}	5.1	1
Peak Non–Repetitive Surge Current (One Half Cycle, 60 Hz, T _J = 110°C)	2/10 =	ITSM	90	
Circuit Fusing Consideration (t = 8.3 msec)		l ² t	34	A ² sec
Peak Gate Power (Pulse Width ≤ 10 μsec, T _C = 90°C)		P _{GM}	5.0	Watts
Average Gate Power (t = 8.3 msec, T _C = 90°C)		P _{G(AV)}	0.5	
Peak Gate Current (Pulse Width ≤ 10 μsec, T _C = 90°C)		I _{GM}	2.0	Amps
Operating Junction Temperature Range		TJ	-40 to 110	°C
Storage Temperature Range	100 0	T _{stg}	-40 to 150	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance — Junction to Case — Junction to Ambient — Junction to Ambient (2)	R _O JC R _O JA R _O JA	2.2 88 80	°C/W
Maximum Lead Temperature for Soldering Purposes (3)	TL	260	°C

(1) V_{DRM} for all types can be applied on a continuous basis. Ratings apply for negative gate voltage or R_{GK} = 1.0 KΩ; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the device are exceeded.

(2) Surface mounted on minimum recommended pad size.

(3) 1/8" from case for 10 seconds.

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referred devices are Motorola recommended choices for future use and best overall value.



ELECTRICAL CHARACTERISTICS (T_J = 25° C; R_{GK} = 1.0 K Ω unless otherwise noted)

Characteristics	Symbol	Min	Тур	Max	Unit
Peak Reverse Gate Blocking Voltage ($I_{GR} = 10 \mu A$)	VGRM	10	12.5	18	Volts
Peak Forward Blocking Current Peak Reverse Blocking Current $ (V_{AK} = Rated \ V_{DRM} \ or \ V_{RRM}) \ (1) \\ T_{J} = 25^{\circ}C \\ T_{J} = 110^{\circ}C $	I _{DRM} IRRM	_ _		10 500	μΑ
Peak Reverse Gate Blocking Current (VGR = 10 V)	IRGM	_	_	1.2	μΑ
Peak On–State Voltage (2) (I _{TM} = 16 A)	V _{TM}	_	1.4	1.8	Volts
Gate Trigger Current (Continuous dc) $^{(3)}$ (V _D = 12 V, R _L = 100 Ω , T _J = 25°C) (V _D = 12 V, R _L = 100 Ω , T _J = -40 °C)	lGT	5.0 —	12 —	200 300	μΑ
Gate Trigger Voltage (Continuous dc) $ (V_D = 12 \text{ V}, \text{ R}_L = 100 \ \Omega, \text{ T}_J = 25^{\circ}\text{C}) \\ (V_D = 12 \text{ V}, \text{ R}_L = 100 \ \Omega, \text{ T}_J = -40^{\circ}\text{C}) \\ (V_D = 12 \text{ V}, \text{ R}_L = 100 \ \Omega, \text{ T}_J = 110^{\circ}\text{C}) $	V _{GT}	0.45 — 0.2	0.65 — —	1.0 1.5 —	Volts
Holding Current $(V_D = 12 \text{ V, I(init)} = 200 \text{ mA, T}_J = 25^{\circ}\text{C})$ $(V_D = 12 \text{ V, I(init)} = 200 \text{ mA, T}_J = -40^{\circ}\text{C})$	lн	0.5 —	1.0	6.0 10	mA
Latching Current $(V_D = 12 \text{ V}, I_G = 2.0 \text{ mA}, T_J = 25^{\circ}\text{C})$ $(V_D = 12 \text{ V}, I_G = 2.0 \text{ mA}, T_J = -40^{\circ}\text{C})$	ΙL	0.5 —	1.0 —	6.0 10	mA

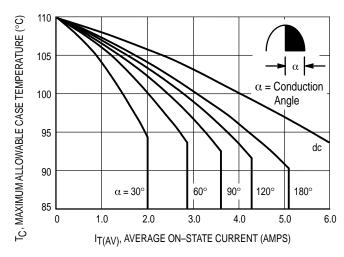
DYNAMIC CHARACTERISTICS

Characteristics	Symbol	Min	Тур	Max	Unit
Total Turn–On Time (Source Voltage = 12 V, R _S = 6.0 K Ω , I _T = 16 A(pk), R _{GK} = 1.0 K Ω) (V _D = Rated V _{DRM} , Rise Time = 20 ns, Pulse Width = 10 μ s)	tgt	ı	2.0	5.0	μs
Critical Rate of Rise of Off–State Voltage ($V_D = 0.67 \text{ X Rated } V_{DRM}$, Exponential Waveform, $R_{GK} = 1.0 \text{ K}\Omega$, $T_J = 110^{\circ}\text{C}$)	dv/dt	2.0	10	_	V/μs

⁽¹⁾ Ratings apply for negative gate voltage or $R_{GK} = 1.0 \text{ K}\Omega$. Devices shall not have a positive gate voltage concurrently with a negative voltage on the anode. Devices should not be tested with a constant current source for forward and reverse blocking capability such that the voltage applied exceeds the rated blocking voltage.

⁽²⁾ Pulse Test; Pulse Width \leq 2.0 msec, Duty Cycle \leq 2%.

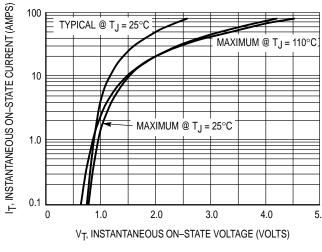
⁽³⁾ Does not include R_{GK} current.



12 P(AV), AVERAGE POWER DISSIPATION (WATTS) 10 - | α |- 180° 8.0 120° α = Conduction 90° Angle 6.0 $\alpha = 30^{\circ}$ 4.0 2.0 0 0 2.0 3.0 4.0 5.0 6.0 I_{T(AV)}, AVERAGE ON-STATE CURRENT (AMPS)

Figure 1. Average Current Derating

Figure 2. On-State Power Dissipation



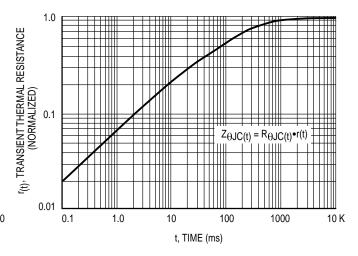
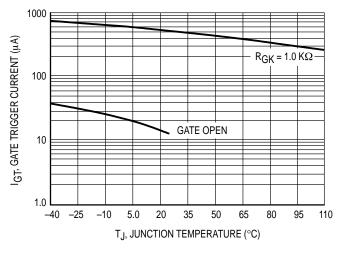


Figure 3. On-State Characteristics

Figure 4. Transient Thermal Response



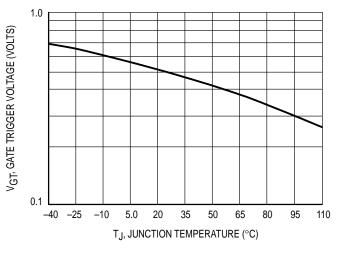


Figure 5. Typical Gate Trigger Current versus Junction Temperature

Figure 6. Typical Gate Trigger Voltage versus
Junction Temperature

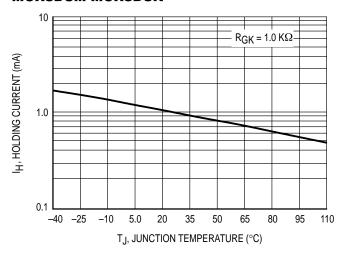


Figure 7. Typical Holding Current versus Junction Temperature

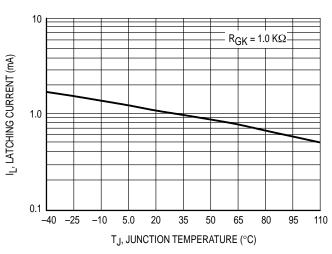
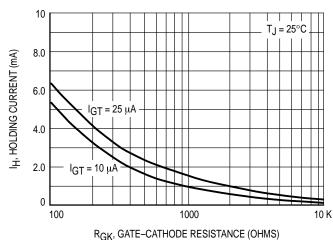
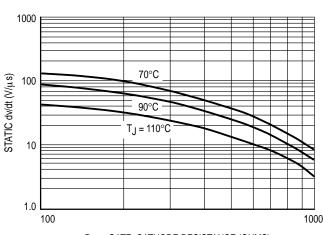


Figure 8. Typical Latching Current versus Junction Temperature





R_{GK}, GATE-CATHODE RESISTANCE (OHMS)

Figure 9. Holding Current versus Gate-Cathode Resistance

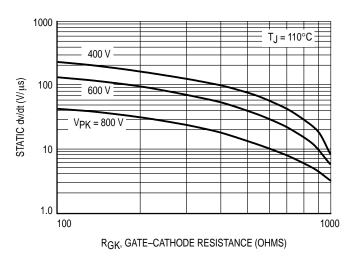
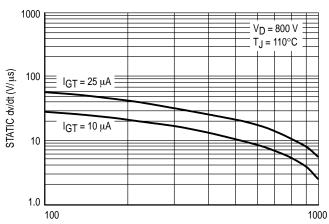


Figure 11. Exponential Static dv/dt versus Gate-Cathode Resistance and Peak Voltage

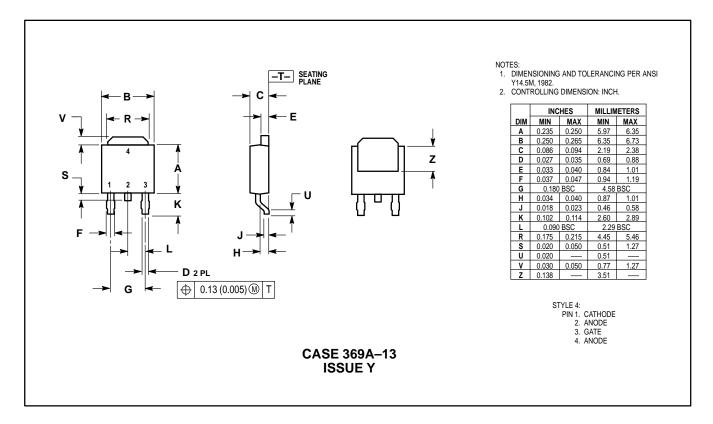
Figure 10. Exponential Static dv/dt versus Gate-Cathode Resistance and Junction Temperature



R_{GK}, GATE-CATHODE RESISTANCE (OHMS)

Figure 12. Exponential Static dv/dt versus Gate-Cathode Resistance and Gate Trigger Current Sensitivity

PACKAGE DIMENSIONS



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